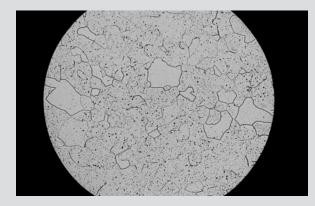
# Heraeus

## **AluBond Prime Wire**

Aluminum Bonding Wire for Extended Corrosion Resistance



AI-H14 CR wires and ribbons consist of high purity aluminum with selected addition elements homogeneously distributed in defined concentrations. The corrosion resistant AI-H14 CR wire fulfils the increasing requirements made on the reliability of bonded connections in automobile and power electronics.

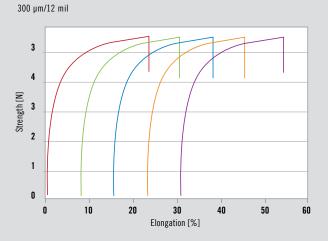
#### Areas of Application

- Automotive components
- Power components
- Hybrid components
- Transistors / thyristors

## AI-H14 CR Benefits

- Best corrosion resistance
- Comes in two versions: medium and soft
- Medium performance for high strength requirements
- Soft performance for extra sensible chip bonding and outstanding soft bonding properties
- Available in both, wire & ribbon shape

Serial Tensile Test Result from Soft AluBond Prime Wire



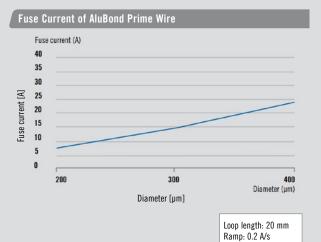
Diameter	Micron	125	200	250	300	380	400	500
	Mil	5	8	10	12	15	16	20
Medium	Elongation [%]	> 10	> 15	> 15	> 15	> 15	> 15	> 15
	Breaking Load [cN]	75-120	200-290	300-450	450-650	700-1050	750-1200	1150-1850
Soft	Elongation [%]		> 10	> 10	> 10	> 10	> 10	> 10
	Breaking Load [cN]		140-200	220-300	320-420	475-675	550-750	850-1150

Recommended Technical Data of AluBond Prime Wire

For other diameters, please contact Heraeus Electronics Product Management

## Characteristics of AluBond Prime Wire

Melting Point	°C	660
Modulus of rigidity	kN / mm <sup>2</sup>	27
Thermal conductivity at 20°C	W / m·K	230
Linear expansion coefficient (20 – 30°C)	10-6·K-1	25.3
Electrical Resistivity at 20°C	µOhm-cm	2.8
Temperature coefficient of electrical resistance (0 – 100°C)	10-3·K-1	4.14
Relative electrical conductivity (IACS) at 20°C	%	64.0
Meter resistance at ø 25 µm (20°C)	Ω/m	57.1





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